
AVR1301: Using the XMEGA DAC

Features

- 12 bit resolution
- Up to 1 M conversions per second
- Continuous drive or sample-and-hold output
- Built-in offset and gain calibration
- High drive capabilities
- Driver source code included

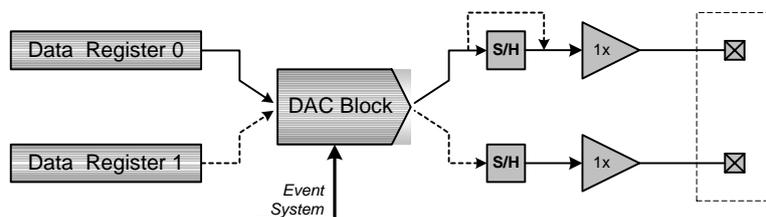
1 Introduction

The XMEGA™ DAC module is a high-performance Digital-to-Analog converter capable of conversion rates up to 1 M conversions per second with a resolution of 12 bits. High output driving capabilities, dual sample-and-hold outputs and optional routing of DAC output to on-board comparator or Analog-to-Digital converter (ADC) make this a flexible module suitable for a huge range of applications, such as stereo sound output, high-speed signal generation, calibration and signal compensation.

This application note describes the basic functionality of the XMEGA DAC with code examples to get up and running quickly. A driver interface written in C is included as well.

Advanced use, such as Direct Memory Access (DMA) and the XMEGA Event System, is outside the scope of this application note. Please refer to the device datasheets and other relevant application notes for details.

Figure 1-1. DAC Overview



8-bit **AVR**[®]
Microcontrollers

Application Note

Rev. 8033B-AVR-04/08





2 Module Overview

This section provides an overview of the basic configuration options and functionality of the DAC. Section 3 then walks you through the basic steps to get up and running, with register descriptions and configuration details.

2.1 Conversion Triggers

A DAC conversion can be triggered either by (1) the data registers being written to or (2) from an incoming event from the XMEGA Event System.

When triggered by data write operations, the conversion starts when the high byte register is updated.

When the Event System is used, the conversion starts when an event arrives, not when the data registers are updated. This means that the data registers can be updated several times without triggering any conversion. When the event arrives, the current value of the data registers are used in the conversion.

Even if software that manually writes to the data registers could achieve fairly good timing, it is recommended to use a timer base together with events and DMA transfers for applications that require precise timing. However, for applications that do not have strict timing requirements or use static output values, it is not necessary to utilize these advanced features.

Trigger mode is configured with the *Trigger Mode* bits (CH_nTRIG) in *Control Register B* ($CTRLB$). Note that trigger mode can be individually configured for the two channels. For instance, channel 0 can be triggered on data write while channel 1 uses events.

2.2 Single and Dual Channel Operation

The DAC module contains two data channels with corresponding data registers, but only one conversion block. The user can choose between using channel 0 as a continuous-drive output or both channels as two Sample/Hold outputs.

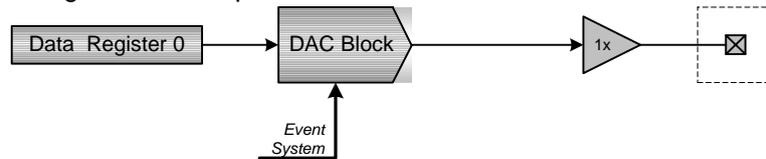
The channel operation mode is configured with the *Channel Select* bitfield ($CHSEL$) in *Control Register B* ($CTRLB$).

2.2.1 Single Channel Operation

In single channel operation, the DAC conversion block is always connected to the data registers and output driver stage of channel 0. Hence the concept *continuous-drive output*.

Figure 2-1 below shows the DAC in single channel operation mode. Note that the Sample/Hold stage is bypassed.

Figure 2-1. Single Channel Operation



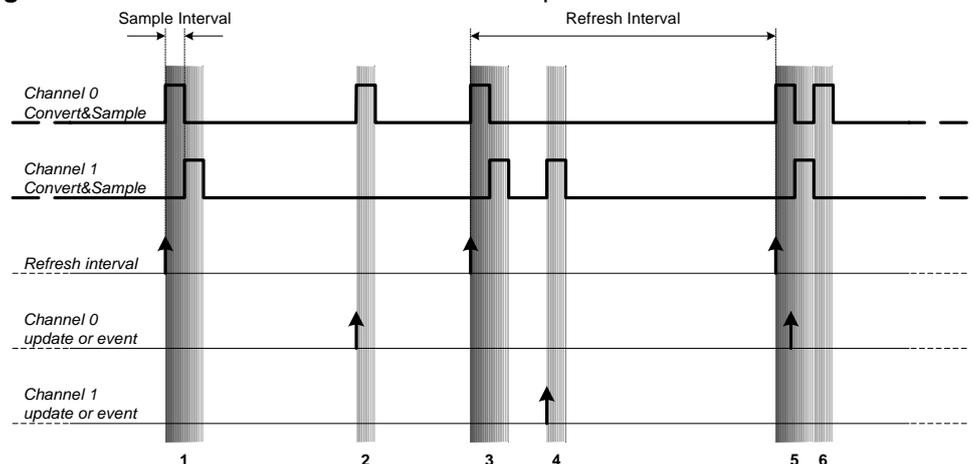
2.2.2 Dual Channel Operation

In dual channel operation, the DAC conversion block is alternately used to convert values for channel 0 and 1. Sample/Hold blocks are used to keep the output values between conversions. To be able to maintain a stable output value on the two outputs, the channels need to be refreshed regularly. Please consult the *Electrical Characteristics* section of the datasheet for details on minimum refresh rate. Note that a higher refresh rate causes higher power consumption. Detail on power consumption versus conversion rate is also found in the datasheet.

The event system could be used to maintain the required refresh rate, but in most cases, the event system is used to generate the sample rate instead. If the sample rate is slower than the refresh rate, the DAC module has an internal refresh interval generator as well. The automatic refresh interval is configured with the *Refresh Timing Control* bitfield (REFRESH) in the *Timing Control* register (TIMCTRL).

Note that manual conversions or event triggering does not affect the refresh interval. This means that the channels will be refreshed at constant intervals even if extra conversions are done in between, caused by for instance a manual update of a data register. Figure 2-2 below shows an example. The *sample interval* is covered in the Section 2.2.3.

Figure 2-2. Channel refresh and conversion request



- 1) A *refresh interval* starts and a conversion and sampling of channel 0 follows. After one *sample interval*, channel 1 is converted and sampled.
- 2) A conversion request (register update or event) for channel 0 triggers a conversion and sampling of channel 0 only, even if we are in the middle of one *refresh interval*.
- 3) Another *refresh interval* starts, similar to 1).



- 4) A conversion request (register update or event) for channel 1 triggers a conversion and sampling of channel 1 only, even if both channels were just refreshed.
- 5) Another refresh interval starts, similar to 1). Note that the conversion request for channel 0 is delayed until 6).
- 6) The delayed conversion request from 5) triggers another conversion and sampling of channel 0 immediately after finishing channel 1.

Note that if the arrival rate of conversion requests approaches the refresh rate, the conversion timing might become imprecise, as an ordinary refresh could be in progress when the conversion request arrives. A request that arrive in the middle of a refresh is delayed until both channels have been refreshed. If more than one request arrives for a channel before the first one is served, the extra requests will be ignored.

If this is a problem for the application in question, a solution is to disable the automatic refresh interval and instead ensure that the data arrives at a high enough rate. Note that it is not possible to turn of automatic refresh for one channel only.

2.2.3 Sample Interval

When using dual channel operation, there is a certain minimum time delay required from conversion of channel 0 starts until channel 1 can start. This is due to a finite settling time of the DAC conversion block output. This delay is minimum 1 μ s, which limits the sample rate to maximum 1 MHz.

The sample interval is configured with the *Channel Separation Control* bitfield (CHSEP) in the *Timing Control* register (TIMCTRL).

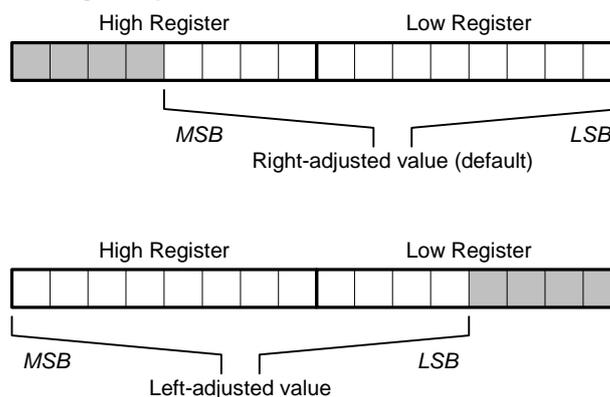
2.3 Left and Right Adjusted Values

The 12-bit input value to the DAC is contained in two 8-bit registers, referred to as the high and low registers. By default, the 12-bit value is distributed with the 8 LSB in the low register and 4 MSB in the high register. This distribution is convenient when the application stores 12-bit DAC values as 16-bit integers, e.g. `unsigned short int`.

However, some applications find it useful to work with left-adjusted data, e.g. 16-bit values where the 4 LSB is treated as a fractional part. Another alternative is that the application stores DAC values in 8-bit variables, e.g. `unsigned char`, and thus leaves the 4 LSB of the 12-bit DAC value equal to zero.

The XMEGA DAC module can be configured to accept left adjusted values by setting the *Left-adjust Value* bit (LEFTADJ) in *Control Register C* (CTRLC). Figure 2-3 shows the difference between right and left adjusted values in the DAC value registers.

Figure 2-3. Left and Right Adjusted Values



2.4 Voltage References

The application can choose between the following voltage references for conversions:

- Bandgap Reference (1.1V)
- Analog voltage supply (V_{DD})
- External reference (V_{REF+})

Note that the external reference pin V_{REF+} is shared with the ADC module. The voltage reference is select with the *Reference* bitfield ($REFSEL$) in *Control Register C* ($CTRLB$).

2.5 Driving Strength

Regardless of operation mode, the DAC outputs are capable of driving external resistive loads of 1 k Ω or capacitive loads of 100 pF. Please refer to the module datasheet for detailed characteristics.

2.6 Calibration

To achieve optimal accuracy for the DAC output, the built-in calibration capabilities allows fine-tuning of process related offset and gain errors. Two registers, *Gain Calibration* ($GAINCAL$) and *Offset Calibration* ($OFFSETCAL$), are used for this purpose. Both calibration register use 7 bits, where the MSB (bit 6) determines the direction of the calibration and the 6 LSBs (bit 5..0) determine the calibration amplitude.

When calibrating the DAC, you need to measure the output somehow. For this purpose, the DAC can be internally connected to one of the ADC channels (with a properly calibration ADC) or some external equipment. Using the XMEGA ADC module enables fully automatic DAC calibration, while using external equipment might give even higher accuracy if required. For more information on the ADC module, please refer to the device datasheet or the application note "AVR1000: Getting Started with the XMEGA ADC".

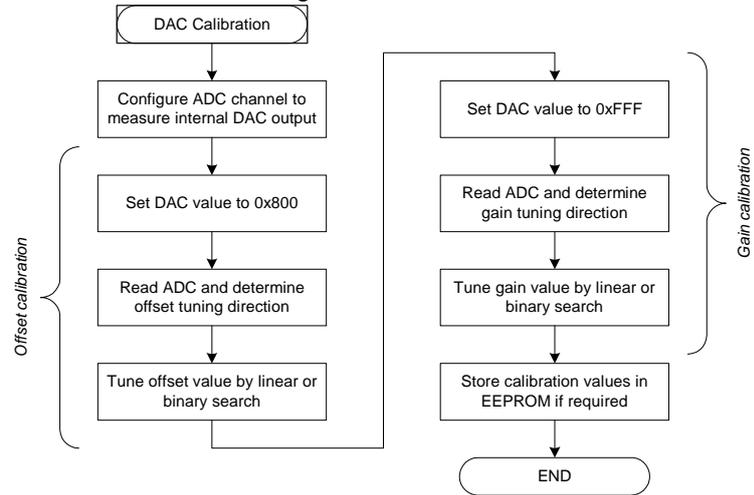
When calibrating, first tune the offset value until a value of 0x800 gives exactly half the reference voltage. Then tune the gain value until a value of 0xFFFF gives exactly

full reference voltage. Note that it is not possible to tune the gain value using 0x000, as the conversion block is not able to reach down to 0V.

The calibration is not affected by single or dual channel modes, as the same DAC block is used for both modes.

A flowchart for the calibration process is shown in Figure 2-4 below.

Figure 2-4. Calibration of DAC using the ADC



3 Getting Started

This section walks you through the basic steps for getting up and running with simple conversions and experimenting with different operating modes. The necessary registers are described along with relevant bit settings.

3.1 Single Channel Operation

Task: Set static value on DAC channel 0 in single channel operation using analog supply voltage as conversion reference.

- Set the *Channel Select* bitfield (CHSEL) in *Control Register B* (CTRLB) equal to 0x00 to select single channel operation.
- Clear the *Event Trig Enable* bit for channel 0 (CH0TRIG) in *Control Register B* (CTRLB) to trigger conversions when data is written, instead of triggering on incoming events.
- Set the *Reference Selection* bitfield (REFSEL) in *Control Register C* (CTRLC) equal to 0x01 to use analog supply voltage as conversion reference.
- Set the *Channel 0 Enable* bit (CH0EN) in *Control Register A* (CTRLA) to enable DAC output 0.
- Set the *Enable* bit (ENABLE) in *Control Register A* (CTRLA) to enable the DAC module itself.
- Write a 12-bit right adjusted value to *Channel 0 Data* register (CH0DATA) to trigger a conversion. Note that the low byte must be written first.

Note that the data registers are right adjusted by default.

3.2 Dual Channel Operation

Task: Set static value on both DAC channels in dual channel operation using analog supply voltage as conversion reference.

- Set the *Channel Select* bitfield (CHSEL) in *Control Register B* (CTRLB) equal to 0x02 to select dual channel operation.
- Clear the *Event Trig Enable* bit for channel 0 and 1 (CH0TRIG and CH1TRIG) in *Control Register B* (CTRLB) to trigger conversions when data is written, instead of triggering on incoming events.
- Set the *Reference Selection* bitfield (REFSEL) in *Control Register C* (CTRLC) equal to 0x01 to use analog supply voltage as conversion reference.
- Set the *Channel 0 Enable* and *Channel 1 Enable* bits (CH0EN and CH1EN) in *Control Register A* (CTRLA) to enable both DAC outputs.
- Set the *Channel Separation* bitfield (CHSEP) in the *Timing Control* register (TIMCTRL) equal to 0x04 to use 16 clock cycles for the sample interval, which means 2 μ s with a peripheral clock of 8 MHz.
- Set the *Refresh Timing* bitfield (REFRESH) in the *Timing Control* register (TIMCTRL) equal to 0x06 to use 128 clock cycles for the refresh interval, which means 16 μ s with a peripheral clock of 8 MHz.
- Set the *Enable* bit (ENABLE) in *Control Register A* (CTRLA) to enable the DAC module itself.
- Write 12-bit right adjusted values to the channel data register to trigger conversions. The outputs will be refreshed every 16 μ s when no data is written to the data registers.

4 Advanced Features

This section introduces more advanced features and possibilities with the DAC. In-depth treatment is outside the scope of this application note and the user is advised to study the device datasheet and relevant application notes.

Note that the DAC module does not use interrupts.

4.1 DMA Controller

Instead of using polling or timed code to write data and start conversions, it is possible to use the XMEGA DMA Controller to move data to the conversion registers from memory buffers or other peripheral modules. This moving of data is done without CPU intervention, and leaves the CPU ready for other tasks. Note that it is recommended to use the Event System as conversion trigger source when using DMA to achieve accurate conversion timing.

For more information, please refer to the device datasheet or the application note “AVR1304: Getting Started with the XMEGA DMA Controller”.

4.2 Event System

To improve conversion timing and further offload work from the CPU, the DAC is connected to the XMEGA Event System. This makes it possible to use incoming events to trigger data conversions.

For more information, please refer to the device datasheet or the application note “AVR1303: Getting Started with the XMEGA Event System”.





5 Driver Implementation

This application note includes a source code package with a basic DAC driver implemented in C. It is written for the IAR Embedded Workbench® compiler, but it is also compatible with AVR-GCC.

Note that this DAC driver is not intended for use with high-performance code. It is designed as a library to get started with the DAC. For timing and code space critical application development, you should access the DAC registers directly. Please refer to the driver source code and device datasheet for more details.

5.1 Files

The source code package consists of three files:

- *dac_driver.c* – DAC driver source file
- *dac_driver.h* – DAC driver header file
- *main.c* – Example code using the driver

Note that the driver and example code does not include support for DMA data transfer or the XMEGA Event System.

For a complete overview of the available driver interface functions and their use, please refer to the source code documentation.

5.2 Doxygen Documentation

All source code is prepared for automatic documentation generation using Doxygen. Doxygen is a tool for generating documentation from source code by analyzing the source code and using special keywords. For more details about Doxygen please visit <http://www.doxygen.org>. Precompiled Doxygen documentation is also supplied with the source code accompanying this application note, available from the *readme.html* file in the source code folder.



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